Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	180MHz
Connectivity	EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	120
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 48x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz1024efe144-e-pl

REGISTER 4-8: SBTxREGy: SYSTEM BUS TARGET 'x' REGION 'y' REGISTER ('x' = 0-13; 'y' = 0-8)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	BASE<21:14>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	BASE<13:6>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	U-0
	BASE<5:0>						PRI	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
	SIZE<4:0>					—	—	—

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared

bit 31-10 **BASE<21:0>:** Region Base Address bits

bit 9 **PRI:** Region Priority Level bit
1 = Level 2
0 = Level 1

bit 8 **Unimplemented:** Read as '0'

bit 7-3 **SIZE<4:0>:** Region Size bits
Permissions for a region are only active is the SIZE is non-zero.
11111 = Region size = $2^{(SIZE - 1)}$ x 1024 (bytes)
•
•
•
00001 = Region size = $2^{(SIZE - 1)}$ x 1024 (bytes)
00000 = Region is not present

bit 2-0 **Unimplemented:** Read as '0'

Note 1: Refer to Table 4-6 for the list of available targets and their descriptions.
2: For some target regions, certain bits in this register are read-only with preset values. See Table 4-6 for more information.

REGISTER 4-10: SBTxWRy: SYSTEM BUS TARGET 'x' REGION 'y' WRITE PERMISSIONS REGISTER ('x' = 0-13; 'y' = 0-8)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-1	R/W-1	R/W-1
	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared

bit 31-4 **Unimplemented:** Read as '0'

bit 3 **Group3:** Group 3 Write Permissions bits
- 1 = Privilege Group 3 has write permission
- 0 = Privilege Group 3 does not have write permission

bit 2 **Group2:** Group 2 Write Permissions bits
- 1 = Privilege Group 2 has write permission
- 0 = Privilege Group 2 does not have write permission

bit 1 **Group1:** Group 1 Write Permissions bits
- 1 = Privilege Group 1 has write permission
- 0 = Privilege Group 1 does not have write permission

bit 0 **Group0:** Group 0 Write Permissions bits
- 1 = Privilege Group 0 has write permission
- 0 = Privilege Group 0 does not have write permission

Note 1: Refer to Table 4-6 for the list of available targets and their descriptions.

2: For some target regions, certain bits in this register are read-only with preset values. See Table 4-6 for more information.

TABLE 7-3: INTERRUPT REGISTER MAP (CONTINUED)

Virtual Address (BF81_#)	Register Name(1)	Bit Range	Bits															All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0638	OFF062	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
063C	OFF063	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0640	OFF064	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0644	OFF065	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0648	OFF066	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
064C	OFF067	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0650	OFF068	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0654	OFF069	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0658	OFF070	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
065C	OFF071	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0660	OFF072	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0664	OFF073	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0668	OFF074	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
066C	OFF075	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000
0670	OFF076	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VOFF<17:16>		0000
		15:0	VOFF<15:1>															—	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table with the exception of the OFFx registers, have corresponding CLR, SET, and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.
2: This bit or register is not available on 64-pin devices.
3: This bit or register is not available on devices without a CAN module.
4: This bit or register is not available on 100-pin devices.
5: Bits 31 and 30 are not available on 64-pin and 100-pin devices; bits 29 through 14 are not available on 64-pin devices.
6: Bits 31, 30, 29, and bits 5 through 0 are not available on 64-pin and 100-pin devices; bit 31 is not available on 124-pin devices; bit 22 is not available on 64-pin devices.
7: This bit or register is not available on devices without a Crypto module.
8: This bit or register is not available on 124-pin devices.

8.0 OSCILLATOR CONFIGURATION

Note: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 42. "Oscillators with Enhanced PLL"** (DS60001250) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

The PIC32MZ EF oscillator system has the following modules and features:

- A total of five external and internal oscillator options as clock sources
- On-Chip PLL with user-selectable input divider, multiplier and output divider to boost operating frequency on select internal and external oscillator sources
- On-Chip user-selectable divisor postscaler on select oscillator sources
- Software-controllable switching between various clock sources
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown with dedicated Back-up FRC (BFRC)
- Dedicated On-Chip PLL for USB peripheral
- Flexible reference clock output
- Multiple clock branches for peripherals for better performance flexibility
- Clock switch/slew control with output divider

A block diagram of the oscillator system is shown in Figure 8-1. The clock distribution is provided in Table 8-1.

Note: Devices that support 252 MHz operation should be configured for SYSCLK <= 200 MHz operation. Adjust the dividers of the PBCLKs, and then increase the SYSCLK to the desired speed.

REGISTER 10-1: DMACON: DMA CONTROLLER CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	U-0	U-0
	ON	—	—	SUSPEND	DMABUSY	—	—	—
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** DMA On bit
- 1 = DMA module is enabled
- 0 = DMA module is disabled

bit 14-13 **Unimplemented:** Read as '0'

bit 12 **SUSPEND:** DMA Suspend bit
- 1 = DMA transfers are suspended to allow CPU uninterrupted access to data bus
- 0 = DMA operates normally

bit 11 **DMABUSY:** DMA Module Busy bit
- 1 = DMA module is active and is transferring data
- 0 = DMA module is disabled and not actively transferring data

bit 10-0 **Unimplemented:** Read as '0'

20.1 SQI Control Registers

TABLE 20-1: SERIAL QUADRATURE INTERFACE (SQI) REGISTER MAP

Virtual Address (BF8E_#)	Register Name	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
2000	SQI1 XCON1	31:16	—	—	—	—	—	—	—	—	DUMMYBYTES<2:0>			ADDRBYTES<2:0>			READOPCODE<7:6>		0000
		15:0	READOPCODE<5:0>						TYPEDATA<1:0>		TYPEDUMMY<1:0>		TYPEMODE<1:0>		TYPEADDR<1:0>		TYPECMD<1:0>		0000
2004	SQI1 XCON2	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	DEVSEL<1:0>		MODEBYTES<1:0>		MODECODE<7:0>								0000
2008	SQI1CFG	31:16	—	—	—	—	—	—	CSEN<1:0>		SQIEN	—	DATAEN<1:0>		CON FIFORST	RXFIFO RST	TXFIFO RST	RESET	0000
		15:0	—	—	—	BURSTEN	—	HOLD	WP	—	—	—	LSBF	CPOL	CPHA	MODE<2:0>			0000
200C	SQI1CON	31:16	—	—	—	—	—	—	—	SCHECK	—	DASSERT	DEVSEL<1:0>		LANEMODE<1:0>		CMDINIT<1:0>		0000
		15:0	TXRXCOUNT<15:0>																0000
2010	SQI1 CLKCON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	CLKDIV<10:8>			0000
		15:0	CLKDIV<7:0>								—	—	—	—	—	—	STABLE	EN	0000
2014	SQI1 CMDTHR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	TXCMDTHR<4:0>					—	—	—	RXCMDTHR<4:0>					0000
2018	SQI1 INTTHR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	TXINTTHR<4:0>					—	—	—	RXINTTHR<4:0>					0000
201C	SQI1 INTEN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	DMAEIE	PKT COMPIE	BD DONEIE	CON THRIE	CON EMPTYIE	CON FULLIE	RX THRIE	RX FULLIE	RX EMPTYIE	TX THRIE	TX FULLIE	TX EMPTYIE	0000
2020	SQI1 INTSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	DMAEIF	PKT COMPIF	BD DONEIF	CON THRIF	CON EMPTYIF	CON FULLIF	RX THRIF	RX FULLIF	RX EMPTYIF	TX THRIF	TX FULLIF	TX EMPTYIF	0000
2024	SQI1 TXDATA	31:16	TXDATA<31:16>																0000
		15:0	TXDATA<15:0>																0000
2028	SQI1 RXDATA	31:16	RXDATA<31:16>																0000
		15:0	RXDATA<15:0>																0000
202C	SQI1 STAT1	31:16	—	—	—	—	—	—	—	—	TXFIFOFREE<7:0>								0000
		15:0	—	—	—	—	—	—	—	—	RXFIFOCNT<7:0>								0000
2030	SQI1 STAT2	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	CMDSTAT<1:0>		0000
		15:0	—	—	—	—	CONAVAIL<4:0>					SDID3	SDID2	SDID1	SDID0	—	RXUN	TXOV	00x0
2034	SQI1 BDCON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	START	POLLEN	DMAEN	0000
2038	SQI1BD CURADD	31:16	BDCURRADDR<31:16>																0000
		15:0	BDCURRADDR<15:0>																0000
2040	SQI1BD BASEADD	31:16	BDADDR<31:16>																0000
		15:0	BDADDR<15:0>																0000

26.0 CRYPTO ENGINE

Note: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 49. "Crypto Engine (CE) and Random Number Generator (RNG)"** (DS60001246) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

The Crypto Engine is intended to accelerate applications that need cryptographic functions. By executing these functions in the hardware module, software overhead is reduced and actions, such as encryption, decryption, and authentication can execute much more quickly.

The Crypto Engine uses an internal descriptor-based DMA for efficient programming of the security association data and packet pointers (allowing scatter/gather data fetching). An intelligent state machine schedules the Crypto Engines based on the protocol selection and packet boundaries. The hardware engines can perform the encryption and authentication in sequence or in parallel.

The following are key features of the Crypto Engine:

- Bulk ciphers and hash engines
- Integrated DMA to off-load processing:
  - Buffer descriptor-based
  - Secure association per buffer descriptor
- Some functions can execute in parallel

Bulk ciphers that are handled by the Crypto Engine include:

- AES:
  - 128-bit, 192-bit, and 256-bit key sizes
  - CBC, ECB, CTR, CFB, and OFB modes
- DES/TDES:
  - CBC, ECB, CFB, and OFB modes

Authentication engines that are available through the Crypto Engine include:

- SHA-1
- SHA-256
- MD-5
- AES-GCM
- HMAC operation (for all authentication engines)

The rate of data that can be processed by the Crypto Engine depends on these factors:

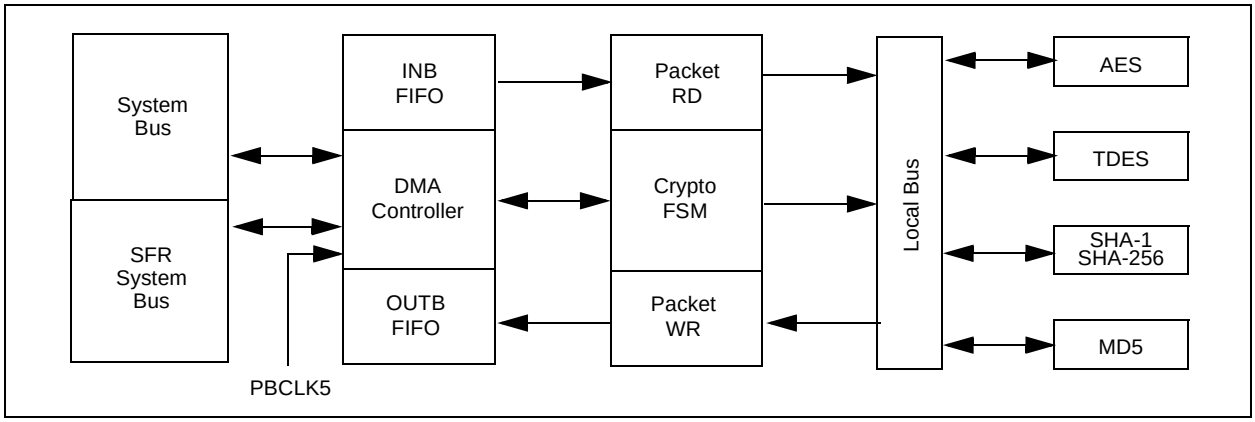
- Which engine is in use
- Whether the engines are used in parallel or in series
- The demands on source and destination memories by other parts of the system (i.e., CPU, DMA, etc.)
- The speed of PBCLK5, which drives the Crypto Engine

Table 26-1 shows typical performance for various engines.

TABLE 26-1: CRYPTO ENGINE PERFORMANCE

Engine/ Algorithm	Performance Factor (Mbps/MHz)	Maximum Mbps (PBCLK5 = 100 MHz)
DES	14.4	1440
TDES	6.6	660
AES-128	9.0	900
AES-192	7.9	790
AES-256	7.2	720
MD5	15.6	1560
SHA-1	13.2	1320
SHA-256	9.3	930

FIGURE 26-1: CRYPTO ENGINE BLOCK DIAGRAM



26.1 Crypto Engine Control Registers

TABLE 26-2: CRYPTO ENGINE REGISTER MAP

Virtual Address (BF8E_#)	Register Name	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
5000	CEVER	31:16	REVISION<7:0>								VERSION<7:0>								0000
		15:0	ID<15:0>																0000
5004	CECON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	SWAPOEN	SWRST	SWAPEN	—	—	BDPCHST	BDPPLEN	DMAEN	0000
5008	CEBDADDR	31:16	BDPADDR<31:0>																0000
		15:0																	0000
500C	CEBDPADDR	31:16	BASEADDR<31:0>																0000
		15:0																	0000
5010	CESTAT	31:16	ERRMODE<2:0>			ERROP<2:0>			ERRPHASE<1:0>		—	—	BDSTATE<3:0>				START	ACTIVE	0000
		15:0	BDCTRL<15:0>																0000
5014	CEINTSRC	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	AREIF	PKTIF	CBDIF	PENDIF	0000
5018	CEINTEN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	AREIE	PKTIE	CBDIE	PENDIE	0000
501C	CEPOLLCON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	BDPPLCON<15:0>																0000
5020	CEHDLEN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	HDRLEN<7:0>								0000
5024	CETRLLEN	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	TRLRLEN<7:0>								0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

REGISTER 26-5: CESTAT: CRYPTO ENGINE STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	ERRMODE<2:0>			ERROP<2:0>			ERRPHASE<1:0>	
23:16	U-0	U-0	R-0	R-0	R-0	R-0	R-0	R-0
	—	—	BDSTATE<3:0>				START	ACTIVE
15:8	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	BDCTRL<15:8>							
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	BDCTRL<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 **ERRMODE<2:0>:** Internal Error Mode Status bits
- 111 = Reserved
- 110 = Reserved
- 101 = Reserved
- 100 = Reserved
- 011 = CEK operation
- 010 = KEK operation
- 001 = Preboot authentication
- 000 = Normal operation

bit 28-26 **ERROP<2:0>:** Internal Error Operation Status bits
- 111 = Reserved
- 110 = Reserved
- 101 = Reserved
- 100 = Authentication
- 011 = Reserved
- 010 = Decryption
- 001 = Encryption
- 000 = Reserved

bit 25-24 **ERRPHASE<1:0>:** Internal Error Phase of DMA Status bits
- 11 = Destination data
- 10 = Source data
- 01 = Security Association (SA) access
- 00 = Buffer Descriptor (BD) access

bit 23-22 **Unimplemented:** Read as '0'

bit 21-18 **BDSTATE<3:0>:** Buffer Descriptor Processor State Status bits

The current state of the BDP:
- 1111 = Reserved
- •
- •
- •
- 0111 = Reserved
- 0110 = SA fetch
- 0101 = Fetch BDP is disabled
- 0100 = Descriptor is done
- 0011 = Data phase
- 0010 = BDP is loading
- 0001 = Descriptor fetch request is pending
- 0000 = BDP is idle

bit 17 **START:** DMA Start Status bit
- 1 = DMA start has occurred
- 0 = DMA start has not occurred

REGISTER 28-6: ADCIMCON2: ADC INPUT MODE CONTROL REGISTER 2

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DIFF31(1)	SIGN31(1)	DIFF30(1)	SIGN30(1)	DIFF29(1)	SIGN29(1)	DIFF28(1)	SIGN28(1)
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DIFF27(1)	SIGN27(1)	DIFF26(1)	SIGN26(1)	DIFF25(1)	SIGN25(1)	DIFF24(1)	SIGN24(1)
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DIFF23(1)	SIGN23(1)	DIFF22(1)	SIGN22(1)	DIFF21(1)	SIGN21(1)	DIFF20(1)	SIGN20(1)
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DIFF19(1)	SIGN19(1)	DIFF18	SIGN18	DIFF17	SIGN17	DIFF16	SIGN16

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **DIFF31:** AN31 Mode bit(1)
1 = AN31 is using Differential mode
0 = AN31 is using Single-ended mode

bit 30 **SIGN31:** AN31 Signed Data Mode bit(1)
1 = AN31 is using Signed Data mode
0 = AN31 is using Unsigned Data mode

bit 29 **DIFF30:** AN30 Mode bit(1)
1 = AN30 is using Differential mode
0 = AN30 is using Single-ended mode

bit 28 **SIGN30:** AN30 Signed Data Mode bit(1)
1 = AN30 is using Signed Data mode
0 = AN30 is using Unsigned Data mode

bit 27 **DIFF29:** AN29 Mode bit(1)
1 = AN29 is using Differential mode
0 = AN29 is using Single-ended mode

bit 26 **SIGN29:** AN29 Signed Data Mode bit(1)
1 = AN29 is using Signed Data mode
0 = AN29 is using Unsigned Data mode

bit 25 **DIFF28:** AN28 Mode bit(1)
1 = AN28 is using Differential mode
0 = AN28 is using Single-ended mode

bit 24 **SIGN28:** AN28 Signed Data Mode bit(1)
1 = AN28 is using Signed Data mode
0 = AN28 is using Unsigned Data mode

bit 23 **DIFF27:** AN27 Mode bit(1)
1 = AN27 is using Differential mode
0 = AN27 is using Single-ended mode

bit 22 **SIGN27:** AN27 Signed Data Mode bit(1)
1 = AN27 is using Signed Data mode
0 = AN27 is using Unsigned Data mode

Note 1: This bit is not available on 64-pin devices.

29.0 CONTROLLER AREA NETWORK (CAN)

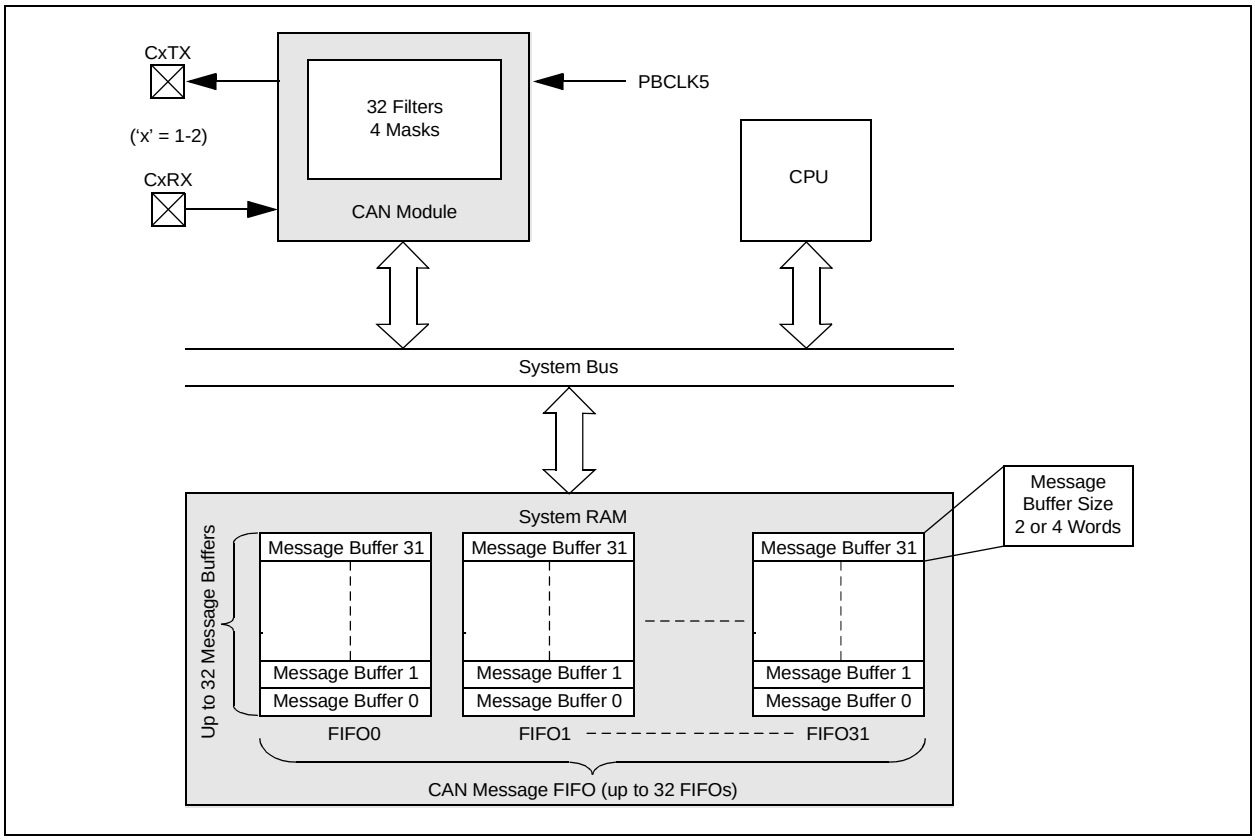
Note: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 34. "Controller Area Network (CAN)"** (DS60001154) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

The Controller Area Network (CAN) module supports the following key features:

- Standards Compliance:
  - Full CAN 2.0B compliance
  - Programmable bit rate up to 1 Mbps
- Message Reception and Transmission:
  - 32 message FIFOs
  - Each FIFO can have up to 32 messages for a total of 1024 messages
  - FIFO can be a transmit message FIFO or a receive message FIFO
  - User-defined priority levels for message FIFOs used for transmission
  - 32 acceptance filters for message filtering
  - Four acceptance filter mask registers for message filtering
  - Automatic response to remote transmit request
  - DeviceNet™ addressing support
- Additional Features:
  - Loopback, Listen All Messages and Listen Only modes for self-test, system diagnostics and bus monitoring
  - Low-power operating modes
  - CAN module is a bus master on the PIC32 System Bus
  - Use of DMA is not required
  - Dedicated time-stamp timer
  - Dedicated DMA channels
  - Data-only Message Reception mode

Figure 29-1 illustrates the general structure of the CAN module.

FIGURE 29-1: PIC32 CAN MODULE BLOCK DIAGRAM



REGISTER 29-20: CiFIFOCONn: CAN FIFO CONTROL REGISTER 'n' ('n' = 0-31)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	FSIZE<4:0>(1)				
15:8	U-0	S/HC-0	S/HC-0	R/W-0	U-0	U-0	U-0	U-0
	—	FRESET	UINC	DONLY(1)	—	—	—	—
7:0	R/W-0	R-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXEN	TXABAT(2)	TXLARB(3)	TXERR(3)	TXREQ	RTREN	TXPR<1:0>	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-21 **Unimplemented:** Read as '0'

bit 20-16 **FSIZE<4:0>:** FIFO Size bits(1)
11111 = FIFO is 32 messages deep
•
•
•
00010 = FIFO is 3 messages deep
00001 = FIFO is 2 messages deep
00000 = FIFO is 1 message deep

bit 15 **Unimplemented:** Read as '0'

bit 14 **FRESET:** FIFO Reset bits
1 = FIFO will be reset when bit is set, cleared by hardware when FIFO is reset. After setting, the user application should poll whether this bit is clear before taking any action
0 = No effect

bit 13 **UINC:** Increment Head/Tail bit
TXEN = 1: (FIFO configured as a Transmit FIFO)
When this bit is set, the FIFO head will increment by a single message
TXEN = 0: (FIFO configured as a Receive FIFO)
When this bit is set, the FIFO tail will increment by a single message

bit 12 **DONLY:** Store Message Data Only bit(1)
TXEN = 1: (FIFO configured as a Transmit FIFO)
This bit is not used and has no effect.
TXEN = 0: (FIFO configured as a Receive FIFO)
1 = Only data bytes will be stored in the FIFO
0 = Full message is stored, including identifier

bit 11-8 **Unimplemented:** Read as '0'

bit 7 **TXEN:** TX/RX Buffer Selection bit
1 = FIFO is a Transmit FIFO
0 = FIFO is a Receive FIFO

Note 1: These bits can only be modified when the CAN module is in Configuration mode (OPMOD<2:0> bits (CiCON<23:21>) = 100).
2: This bit is updated when a message completes (or aborts) or when the FIFO is reset.
3: This bit is reset on any read of this register or when the FIFO is reset.

30.0 ETHERNET CONTROLLER

Note: This data sheet summarizes the features of the PIC32MZ EF family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 35. "Ethernet Controller"** (DS60001155) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32).

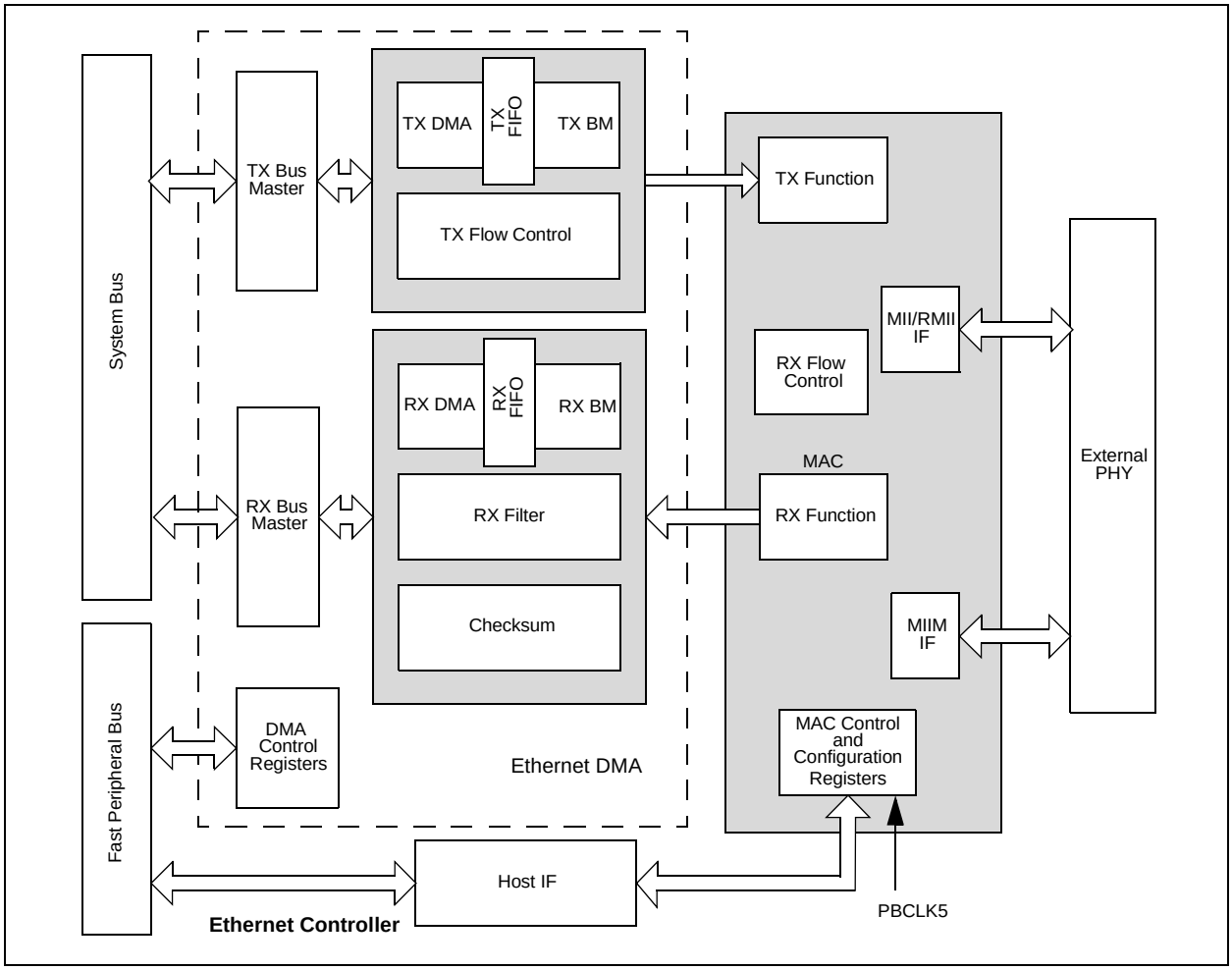
The Ethernet controller is a bus master module that interfaces with an off-chip Physical Layer (PHY) to implement a complete Ethernet node in a system.

Key features of the Ethernet Controller include:

- Supports 10/100 Mbps data transfer rates
- Supports full-duplex and half-duplex operation
- Supports RMII and MII PHY interface
- Supports MIIM PHY management interface
- Supports both manual and automatic Flow Control
- RAM descriptor-based DMA operation for both receive and transmit path
- Fully configurable interrupts
- Configurable receive packet filtering
  - CRC check
  - 64-byte pattern match
  - Broadcast, multicast and unicast packets
  - Magic Packet™
  - 64-bit hash table
  - Runt packet
- Supports packet payload checksum calculation
- Supports various hardware statistics counters

Figure 30-1 illustrates a block diagram of the Ethernet controller.

FIGURE 30-1: ETHERNET CONTROLLER BLOCK DIAGRAM



34.3 On-Chip Voltage Regulator

The core and digital logic for all PIC32MZ EF devices is designed to operate at a nominal 1.8V. To simplify system designs, devices in the PIC32MZ EF family incorporate an on-chip regulator providing the required core logic voltage from VDD.

34.3.1 ON-CHIP REGULATOR AND POR

It takes a fixed delay for the on-chip regulator to generate an output. During this time, designated as TPU, code execution is disabled. TPU is applied every time the device resumes operation after any power-down, including Sleep mode.

34.3.2 ON-CHIP REGULATOR AND BOR

PIC32MZ EF devices also have a simple brown-out capability. If the voltage supplied to the regulator is inadequate to maintain a regulated level, the regulator Reset circuitry will generate a Brown-out Reset. This event is captured by the BOR flag bit (RCON<1>). The brown-out voltage levels are specific in **Section 37.1 "DC Characteristics"**.

34.4 On-chip Temperature Sensor

PIC32MZ EF devices include a temperature sensor that provides accurate measurement of a device's junction temperature (see **Section 37.2 "AC Characteristics and Timing Parameters"** for more information).

The temperature sensor is connected to the ADC module and can be measured using the shared S&H circuit (see **Section 28.0 "12-bit High-Speed Successive Approximation Register (SAR) Analog-to-Digital Converter (ADC)"** for more information).

34.5 Programming and Diagnostics

PIC32MZ EF devices provide a complete range of programming and diagnostic features that can increase the flexibility of any application using them. These features allow system designers to include:

- Simplified field programmability using two-wire In-Circuit Serial Programming™ (ICSP™) interfaces
- Debugging using ICSP
- Programming and debugging capabilities using the EJTAG extension of JTAG
- JTAG boundary scan testing for device and board diagnostics

PIC32 devices incorporate two programming and diagnostic modules, and a trace controller, that provide a range of functions to the application developer.

FIGURE 34-1: BLOCK DIAGRAM OF PROGRAMMING, DEBUGGING AND TRACE PORTS

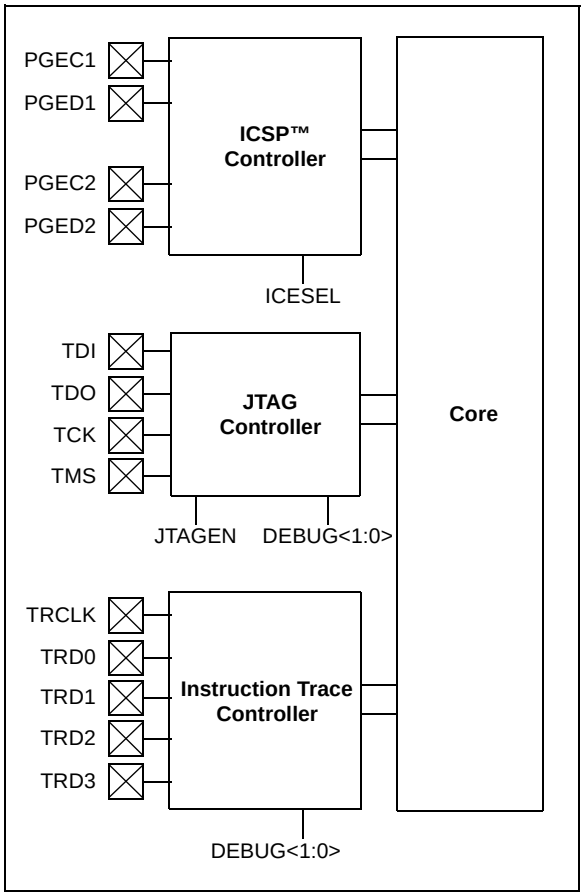


TABLE 37-10: DC CHARACTERISTICS: I/O PIN INPUT INJECTION CURRENT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typical(1)**	**Max.**	**Units**	**Conditions**
DI60a	IICL	**Input Low Injection Current**	0	—	-5(2,5)	mA	This parameter applies to all pins, with the exception of RB10. Maximum IICH current for this exception is 0 mA.
DI60b	IICH	**Input High Injection Current**	0	—	+5(3,4,5)	mA	This parameter applies to all pins, with the exception of all 5V tolerant pins, OSCI, OSCO, SOSCI, SOSCO, D+, D- and RB10. Maximum IICH current for these exceptions is 0 mA.
DI60c	∑IICT	**Total Input Injection Current (sum of all I/O and control pins)**	-20(6)	—	+20(6)	mA	Absolute instantaneous sum of all ± input injection currents from all I/O pins (| IICL + | IICH |) ≤ ∑IICT

Note 1: Data in “Typical” column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: VIL source < (VSS - 0.3). Characterized but not tested.

3: VIH source > (VDD + 0.3) for non-5V tolerant pins only.

4: Digital 5V tolerant pins do not have an internal high side diode to VDD, and therefore, cannot tolerate any “positive” input injection current.

5: Injection currents > | 0 | can affect the ADC results by approximately 4 to 6 counts (i.e., VIH Source > (VDD + 0.3) or VIL source < (VSS - 0.3)).

6: Any number and/or combination of I/O pins not excluded under IICL or IICH conditions are permitted provided the “absolute instantaneous” sum of the input injection currents from all pins do not exceed the specified limit. If **Note 2**, IICL = (((Vss - 0.3) - VIL source) / Rs). If **Note 3**, IICH = ((IICH source - (VDD + 0.3)) / RS). RS = Resistance between input source voltage and device pin. If (VSS - 0.3) ≤ VSOURCE ≤ (VDD + 0.3), injection current = 0.

TABLE 37-14: COMPARATOR SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions (see Note 3): 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typical**	**Max.**	**Units**	**Comments**
D300	VIOFF	Input Offset Voltage	—	±10	—	mV	AVDD = VDD, AVSS = VSS
D301	VICM	Input Common Mode Voltage	0	—	VDD	V	AVDD = VDD, AVSS = VSS **(Note 2)**
D302	CMRR	Common Mode Rejection Ratio	55	—	—	dB	Max VICM = (VDD – 1)V **(Note 2, 4)**
D303	TRESP	Response Time	—	150	—	ns	AVDD = VDD, AVSS = VSS **(Notes 1, 2)**
D304	ON2OV	Comparator Enabled to Output Valid	—	—	10	µs	Comparator module is configured before setting the comparator ON bit **(Note 2)**
D305	IVREF	Internal Voltage Reference	1.194	1.2	1.206	V	—

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from VSS to VDD.

2: These parameters are characterized but not tested.

3: The Comparator module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is guaranteed, but not characterized.

4: CMRR measurement characterized with a 1 MΩ resistor in parallel with a 25 pF capacitor to VSS.

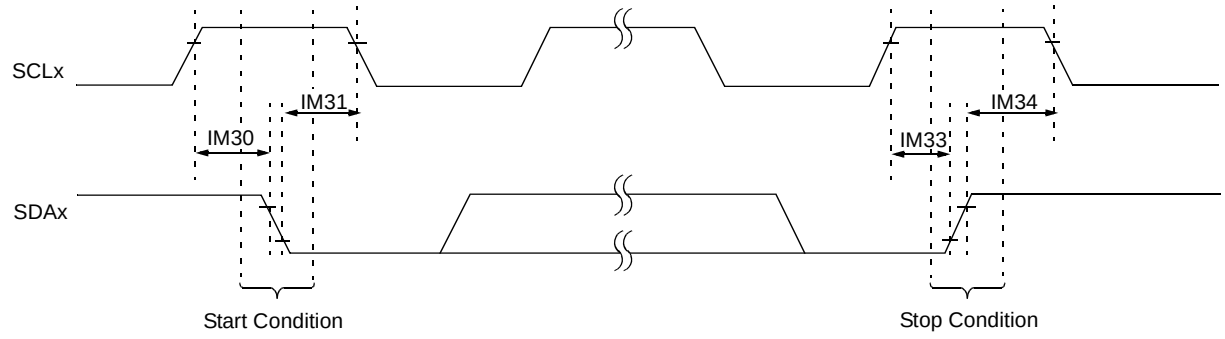
TABLE 37-15: COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions (see Note 3): 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typ.**	**Max.**	**Units**	**Comments**
D312	TSET	Internal 4-bit DAC Comparator Reference Settling time	—	—	10	µs	See **Note 1**
D313	DACREFH	CVREF Input Voltage Reference Range	AVSS	—	AVDD	V	CVRSRC with CVRSS = 0
			VREF-	—	VREF+	V	CVRSRC with CVRSS = 1
D314	DVREF	CVREF Programmable Output Range	0	—	0.625 x DACREFH	V	0 to 0.625 DACREFH with DACREFH/24 step size
			0.25 x DACREFH	—	0.719 x DACREFH	V	0.25 x DACREFH to 0.719 DACREFH with DACREFH/32 step size
D315	DACRES	Resolution	—	—	DACREFH/24		CVRCON<CVRR> = 1
			—	—	DACREFH/32		CVRCON<CVRR> = 0
D316	DACACC	Absolute Accuracy(2)	—	—	1/4	LSB	DACREFH/24, CVRCON<CVRR> = 1
			—	—	1/2	LSB	DACREFH/32, CVRCON<CVRR> = 0

Note 1: Settling time was measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but is not tested in manufacturing.

2: These parameters are characterized but not tested.

FIGURE 37-16: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)



Note: Refer to Figure 37-1 for load conditions.

FIGURE 37-17: I2Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)

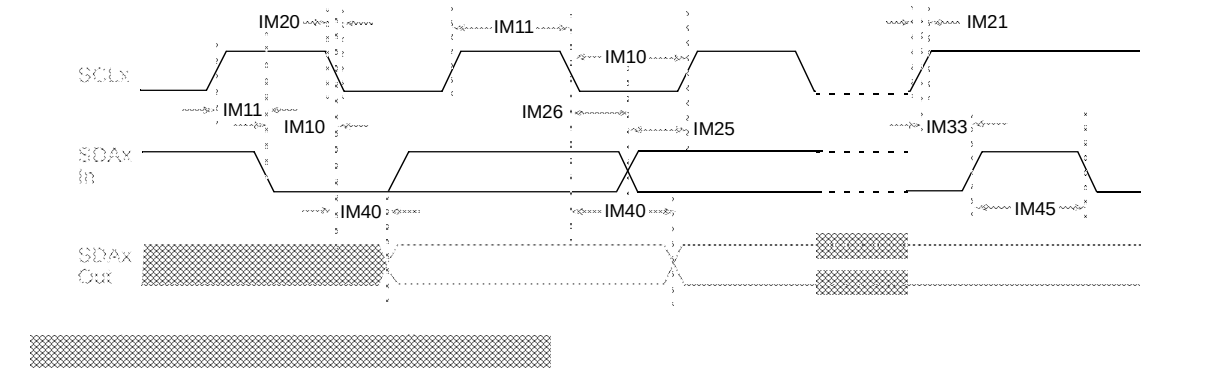


TABLE 37-35: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param. No.	**Symbol**	**Characteristics**		**Min.(1)**	**Max.**	**Units**	**Conditions**
IM10	TLO:SCL	Clock Low Time	100 kHz mode	TPBCLK2 * (BRG + 2)	—	µs	—
			400 kHz mode	TPBCLK2 * (BRG + 2)	—	µs	—
			1 MHz mode **(Note 2)**	TPBCLK2 * (BRG + 2)	—	µs	—
IM11	THI:SCL	Clock High Time	100 kHz mode	TPBCLK2 * (BRG + 2)	—	µs	—
			400 kHz mode	TPBCLK2 * (BRG + 2)	—	µs	—
			1 MHz mode **(Note 2)**	TPBCLK2 * (BRG + 2)	—	µs	—
IM20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode **(Note 2)**	—	100	ns	

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

TABLE 38-4: DC CHARACTERISTICS: POWER-DOWN CURRENT (I_{PD})

DC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ T_A ≤ +125°C for Extended		
Param. No.	**Typical(2)**	**Maximum(5)**	**Units**	**Conditions**	
Power-Down Current (I_{PD}) (Note 1)					
EDC40m	20	46	mA	+125ºC	Base Power-Down Current
Module Differential Current					
EDC41e	15	50	µA	3.6V	Watchdog Timer Current: ΔI_{WDT} **(Note 3)**
EDC42e	25	50	µA	3.6V	RTCC + Timer1 w/32 kHz Crystal: ΔI_{RTCC} **(Note 3)**
EDC43d	3	3.8	mA	3.6V	ADC: ΔI_{ADC} **(Notes 3, 4)**
EDC44	15	50	µA	3.6V	Deadman Timer Current: ΔI_{DMT} **(Note 3)**

Note 1: The test conditions for I_{PD} current measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL is disabled (USBMD = 1), V_{USB3V3} is connected to V_{SS}
- CPU is in Sleep mode
- L1 Cache and Prefetch modules are disabled
- No peripheral modules are operating, (ON bit = 0), and the associated PMD bit is set. All clocks are disabled ON bit (PBxDIV<15>) = 0 (x ≠ 1,7)
- WDT, DMT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to V_{SS}
- $\overline{MCLR}$ = V_{DD}
- RTCC and JTAG are disabled
- Voltage regulator is in Stand-by mode (VREGS = 0)

2: Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

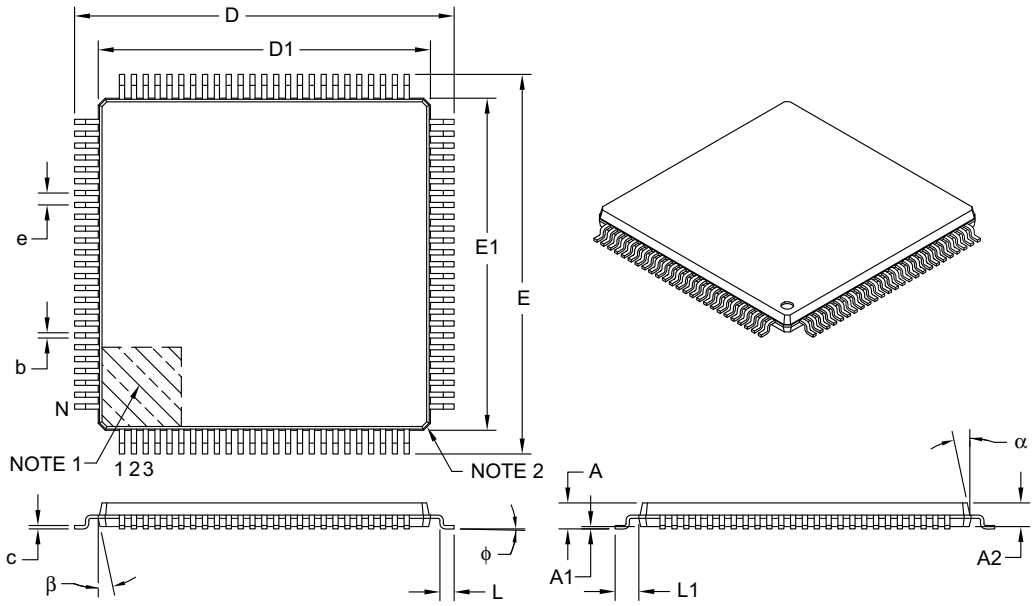
3: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base I_{PD} current.

4: Voltage regulator is operational (VREGS = 1).

5: Data in the "Maximum" column is at 3.3V, +125ºC at specified operating frequency, unless otherwise stated. Parameters are for design guidance only and are not tested.

100-Lead Plastic Thin Quad Flatpack (PF) – 14x14x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		100	
Lead Pitch	e		0.50 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		16.00 BSC	
Overall Length	D		16.00 BSC	
Molded Package Width	E1		14.00 BSC	
Molded Package Length	D1		14.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

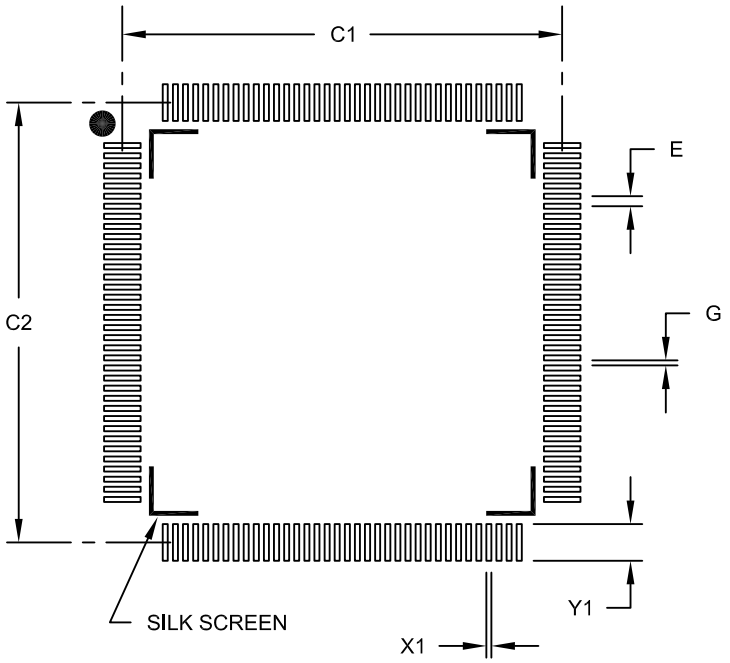
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-110B

144-Lead Plastic Thin Quad Flat Pack (PH) - 16x16 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Contact Pad Spacing	C1		17.40	
Contact Pad Spacing	C2		17.40	
Contact Pad Width (X144)	X1			0.20
Contact Pad Length (X144)	Y1			1.45
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2155B